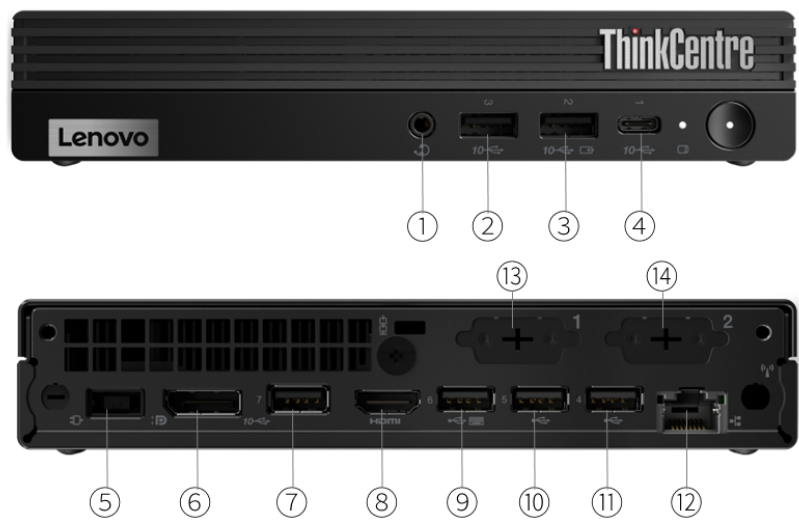


OVERVIEW



1. Headphone / microphone combo jack (3.5mm)	8. HDMI
2. USB-A (USB 10Gbps)	9. USB-A (Hi-Speed USB), with Smart Power On
3. USB-A (USB 10Gbps), Always On	10. USB-A (Hi-Speed USB)
4. USB-C (USB 10Gbps), data transfer only	11. USB-A (Hi-Speed USB)
5. Power connector	12. Ethernet (GbE RJ-45)
6. DisplayPort 1.4a	13. Punch out port 1 *
7. USB-A (USB 10Gbps)	14. Punch out port 2 *

Notes:

- Items with * are only available on selected models

PERFORMANCE

Processor

Processor Family

AMD Ryzen™ 3 / 5 8000 or Ryzen™ 3 / 5 / 7 PRO 8000 Series Processor

Processor**

Processor Name	Cores	Threads	Base Frequency	Max Frequency	Cache	Processor Graphics	NPU
AMD Ryzen™ 3 8300GE	4	8	3.5GHz	4.9GHz	4MB L2 / 8MB L3	AMD Radeon™ 740M	-
AMD Ryzen™ 3 PRO 8300GE	4	8	3.5GHz	4.9GHz	4MB L2 / 8MB L3	AMD Radeon™ 740M	-
AMD Ryzen™ 5 8500GE	6	12	3.4GHz	5.0GHz	6MB L2 / 16MB L3	AMD Radeon™ 740M	-
AMD Ryzen™ 5 PRO 8500GE	6	12	3.4GHz	5.0GHz	6MB L2 / 16MB L3	AMD Radeon™ 740M	-
AMD Ryzen™ 5 PRO 8600GE	6	12	3.9GHz	5.0GHz	6MB L2 / 16MB L3	AMD Radeon™ 760M	AMD Ryzen™ AI
AMD Ryzen™ 7 PRO 8700GE	8	16	3.6GHz	5.1GHz	8MB L2 / 16MB L3	AMD Radeon™ 780M	AMD Ryzen™ AI

Operating System

Operating System**

- Windows® 11 Pro
- Windows® 11 Home
- Windows® 11 IoT Enterprise LTSC 2024
- Windows® 11 DG Windows® 10 Pro 64
- Ubuntu Linux
- IGEL Linux (with License)
- IGEL Linux (no License)^[1]
- No preload operating system

Notes:

[1] The device is preload with a free evaluation license. The evaluation license will be valid for a period of 90 days.

Graphics

Graphics**^[1]

Graphics	Type	Memory	TGP	Connector	Key Features
AMD Radeon™ 740M	Integrated	Shared	Share CPU TDP	3840x2160@60Hz(HDMI®), 3840x2160@60Hz(DP), 1920x1200@60Hz(VGA), 3840x2160@60Hz(USB-C® with DP function)	DirectX® 12
AMD Radeon™ 760M	Integrated	Shared	Share CPU TDP	3840x2160@60Hz(HDMI®), 3840x2160@60Hz(DP), 1920x1200@60Hz(VGA), 3840x2160@60Hz(USB-C® with DP function)	DirectX® 12
AMD Radeon™ 780M	Integrated	Shared	Share CPU TDP	3840x2160@60Hz(HDMI®), 3840x2160@60Hz(DP), 1920x1200@60Hz(VGA), 3840x2160@60Hz(USB-C® with DP function)	DirectX® 12

Notes:

[1] The information of integrated graphics are not applicable for the models with processor which has no integrated graphics inside (for the details, please refer to processor section).

Monitor Support

Monitor Support

Supports up to 4 independent displays via onboard ports (DisplayPort™ + HDMI®) and optional ports (VGA / 2nd DP / 2nd HDMI® / USB-C® / 2x DP)

Chipset

Chipset

AMD PRO 600 chipset

Memory

Max Memory^[1]

Up to 32GB (2x 16GB DDR5 SO-DIMM); 64GB (2x 32GB) is special bids only

Memory Slots

Two DDR5 SO-DIMM slots, dual-channel capable

Memory Type^[2]

DDR5-5200

Notes:

- [1] The max memory is based on the test results with current Lenovo® memory offerings.
- [2] Installed memory is actually DDR5-5600 but will run at DDR5-5200 due to the memory support capability of processor.

Storage

Max Storage Support^[1]

Up to two drives, 2x M.2 2280 SSD, up to 1TB each

Storage Type

Disk Type	Interface	Offering	Security
M.2 2280 SSD	PCIe® NVMe®, PCIe® 4.0 x4	256GB / 512GB / 1TB	Opal 2.0
M.2 2280 SSD ^[2]	PCIe® NVMe®, PCIe® 4.0 x4 Performance	512GB / 1TB / 2TB	Opal 2.0

Notes:

- [1] The max capacity of each disk type is based on the test results with current Lenovo® storage offerings.
- [2] 1TB Performance SSD is special bids only.

Removable Storage

Optical

None

Card Reader

No card reader

Multi-Media

Audio Chip

High Definition (HD) Audio, Realtek® ALC233 codec

Speakers

- No speakers
- Single speaker

Power Supply

Power Supply**

Power	Type	Efficiency	Key Features
65W	Adapter	89%	Autosensing
90W	Adapter	89%	Autosensing

135W	Adapter	89%	Autosensing
No power adapter	-	-	-

DESIGN

Input Device

Keyboard**

- Lenovo® Calliope Keyboard (USB connector), black
- Lenovo® Traditional Keyboard (USB connector), black
- Wireless EOS Keyboard, black
- No keyboard

Mouse**

- Wireless EOS Mouse, black
- Lenovo® Calliope Mouse (USB connector), black
- No mouse

Mechanical

Form Factor

Tiny (1L)

Dimensions (WxDxH)^[1]

Models	Dimensions
Tiny only	179 x 182.9 x 36.5 mm with rubber feet (7.05 x 7.2 x 1.44 inches)

Packaging Dimensions (WxDxH)

494 x 250 x 128 mm (19.45 x 9.84 x 5.04 inches)

Weight^[2]

Models	Weight
Tiny only	Around 1.25 kg (2.76 lbs)

Case Color

Black

Expansion Slots

Three M.2 slots (one for WLAN, two for SSD)

EOU

(Optional) toolless chassis open (toolless chassis screw required) and toolless M.2 SSD, memory assembly / removal

Stand

- Vertical stand
- No stand

IO Box

No IO box

Mounting

- VESA mount bracket kit, supports VESA mount 75mm and 100mm
- None

Others

- (Optional) Dust filter
- (Optional) Power adapter cage

Notes:

[1] The system dimensions may vary depending on configurations.

[2] The system weight is approximate and based on results in Lenovo® lab, which varies depending on the source of component, variance of the distribution of each component, and manufacturing process. It may not be the exact weight for each specific model.

CONNECTIVITY

Network

WLAN + Bluetooth[®]**

- MediaTek Wi-Fi[®] 6 MT7921, 802.11ax 2x2 Wi-Fi[®] + Bluetooth[®] 5.3, M.2 Card^[1]
- Realtek[®] Wi-Fi[®] 6 RTL8852BE, 802.11ax Dual Band 2x2 Wi-Fi[®] + Bluetooth[®] 5.3, M.2 card^[2]
- AMD Wi-Fi[®] 6E RZ616, 802.11ax 2x2 Wi-Fi[®] + Bluetooth[®] 5.3, M.2 Card^[3]
- No WLAN and Bluetooth[®]

Onboard Ethernet

Gigabit Ethernet, Realtek[®] RTL8111FP, 1x RJ-45, supports DASH and Wake-on-LAN

Optional Ethernet

No optional Ethernet

Notes:

[1], [2], [3] Wi-Fi[®] 6E full features might be limited by country-level restrictions.

6GHz Wi-Fi[®] 6E operation is dependent on the support of the operating system, routers/APs/Gateways that support Wi-Fi[®] 6E, and the regional regulatory certifications & spectrum allocation.

Bluetooth[®] 5.3 operation requires Windows[®] 11. For more information please visit [General Bluetooth[®] Support Information on Microsoft[®]](#).

Ports^[1]

Front Ports

- 1x USB-C[®] (USB 10Gbps / USB 3.2 Gen 2), with 5V@0.9A charging
- 1x USB-A (USB 10Gbps / USB 3.2 Gen 2), with Always On and 5V@2.1A charging
- 1x USB-A (USB 10Gbps / USB 3.2 Gen 2)
- 1x headphone / microphone combo jack (3.5mm)

Optional Front Ports

None

Rear Ports^[2]

- 1x USB-A (USB 10Gbps / USB 3.2 Gen 2)
- 3x USB-A (Hi-Speed USB / USB 2.0)
- 1x HDMI[®] 2.1 TMDS
- 1x DisplayPort[™] 1.4 (HBR2, DSC)
- 1x Ethernet (RJ-45)

Optional Rear Ports

- Punch out port 1 (one of VGA / DisplayPort[™] / HDMI[®] / serial / USB-C[®] 3.2 Gen 1 with DisplayPort[™] functions)
- Punch out port 2 (serial)
- 2x USB 3.2 Gen 1 ports (share one USB 3.2 Gen 1 bandwidth, occupy optional port 1 and 2)
- 2x DP (occupies port 1 and 2)

Notes:

[1] The transfer speed of following ports will vary and, depending on many factors, such as the processing speed of the host device, file attributes and other factors related to system configuration and your operating environment, will be slower than theoretical speed.

USB 2.0: 480 Mbit/s;

USB 3.2 Gen 1 (SuperSpeed USB 5Gbps, formerly USB 3.0 / USB 3.1 Gen 1): 5 Gbit/s;

USB 3.2 Gen 2 (SuperSpeed USB 10Gbps, formerly USB 3.1 Gen 2): 10 Gbit/s;

USB4[®] 20Gbps / USB 3.2 Gen 2x2 (SuperSpeed USB 20Gbps): 20 Gbit/s;

USB4[®] 40Gbps (USB 40Gbps): 40 Gbit/s;

Thunderbolt[™] 3/4: 40 Gbit/s.

[2] For video ports on discrete graphics, please see graphics section.

SECURITY & PRIVACY

Security

Security Chip

Discrete TPM 2.0, TCG certified, FIPS 140-2 certified

Physical Locks

Kensington® Security Slot™, 3 x 7 mm

Chassis Intrusion Switch

Chassis intrusion switch^[1]

Fingerprint Reader

No fingerprint reader

BIOS Security

- Administrator password
- Hard disk password
- Power-on password
- Absolute persistence module
- Boot sequence control
- Boot without keyboard and mouse
- Cover tamper detected
- Certificate-based BIOS authentication
- Configuration change detection
- Individual USB port disablement
- Secure wipe
- Secure boot
- Smart USB protection
- More BIOS security features, please visit [BIOS Simulator](#)^[2]

Notes:

[1] Chassis intrusion switch is hardware ready function and needs to be special bid or manually enabled in BIOS.

[2] The BIOS simulator is just for reference. Default settings and some options may vary depending on the hardware, operating system and BIOS version.

MANAGEABILITY

System Management

System Management^[1]

- DASH
- Non-DASH

Notes:

[1] Intel® vPro® offers a superset of DASH's defined capabilities.

SERVICE

Warranty^[1]

Base Warranty**

- 1-year courier or carry-in service
- 1-year limited onsite service
- 3-year limited onsite service
- No base warranty

Notes:

[1] The warranty upgrades may be bundled with some models, please check the "Included upgrade" column in the specific model's configurations. For more service extensions, please go to <https://smartfind.lenovo.com/>. To learn more details of warranty policy, please access <https://support.lenovo.com/warrantylookup/warrantypolicy>.

ACCESSORIES

Bundled Accessories

Bundled Accessories***

- DP to DVI dongle
- DP to Dual DP dongle

- DP to HDMI® dongle
- DP to VGA cable (1.5m)
- DP to VGA dongle
- HDMI® to VGA dongle
- None

OPERATING REQUIREMENTS

Operating Environment

Temperature

- Operating: 5°C (41°F) to 35°C (95°F)
- Storage: -40°C (-40°F) to 60°C (140°F)

Relative Humidity

- Operating: 20% to 80%
- Storage: 10% to 90%

Altitude

- Operating: 0 m (0 ft) to 3048 m (10,000 ft)
- Storage: 0 m (0 ft) to 12192 m (40,000 ft)

CERTIFICATIONS

Green Certifications^[1]

Green Certifications

- (Optional) ENERGY STAR® 8.0
- (Optional) EPEAT™ Gold Registered^[2]
- ErP Lot 3
- RoHS compliant
- TCO Certified 9.0

Notes:

[1] The items listed under the "Green Certifications" section may not only refer to certification but also registration or self-declaration. For ESG & regulatory compliance documents, please visit <https://compliance.lenovo.com>.

[2] EPEAT™ is registered where applicable, please visit epeat.net for registration status by country.

Other Certifications

Other Certifications

(Optional) TÜV Rheinland® Ultra Low Noise

Mil-Spec Test

MIL-STD-810H military test passed (Low Pressure [Altitude], High Temperature, Low Temperature, Temperature Shock, Humidity, Sand and Dust, Vibration, Shock, Solar Radiation, Contamination by Fluids, Salt Fog)

- Feature with ** means that only one option listed under the feature can be configured on selected models. Please refer to the model configuration for specific information.
- Feature with *** means that one or more options listed under the feature can be configured on selected models. Please refer to the model configuration for specific information.
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AMD



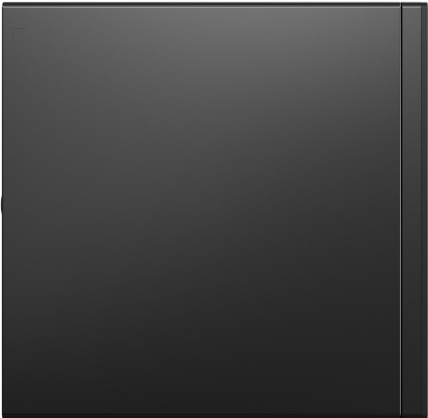
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